

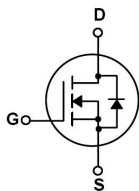
/ Descriptions

/ Features

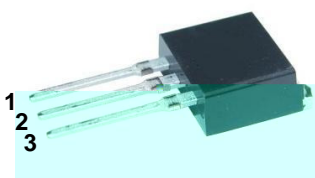
/ Applications

DC/DC

/ Equivalent Circuit



/ Pinning

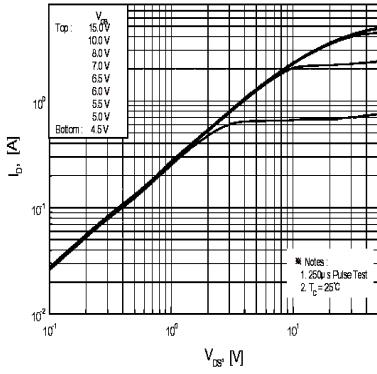


/ h_{FE} Classifications & Marking

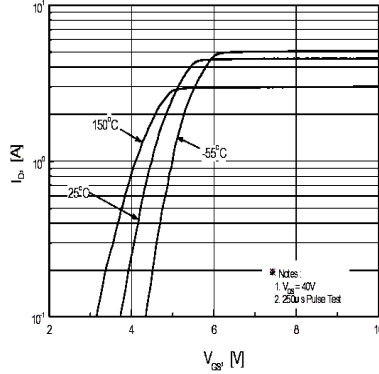
		μ				
						μ
						μ
						μ
		μ				

/ Electrical Characteristic Curve

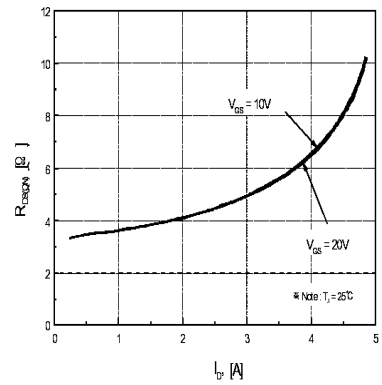
$I_D - V_{DS}$



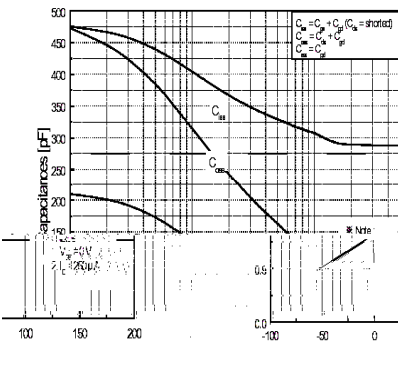
$I_D - V_{GS}$



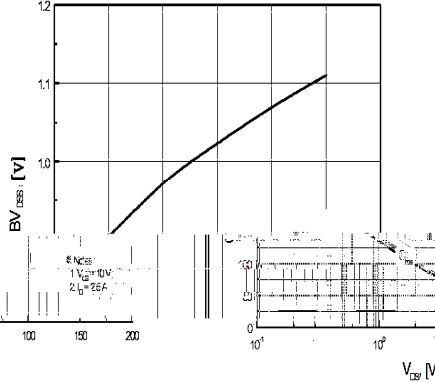
$R_{DS(ON)} - I_D$



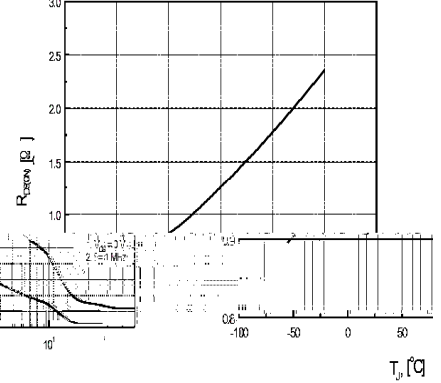
$C_{iss}, C_{oss}, C_{rss} - V_{DS}$



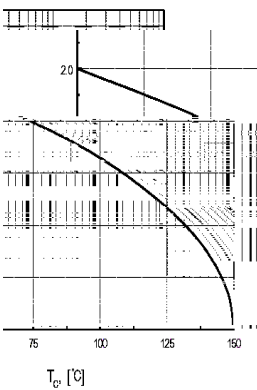
$BV_{DSS} - T_J$



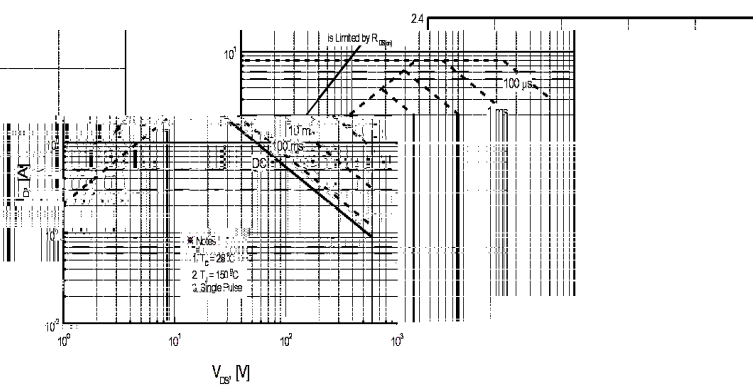
$R_{DS(ON)} - T_J$



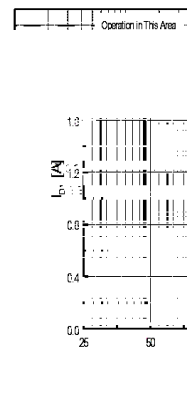
$\theta_{JC} - V_{DS}$



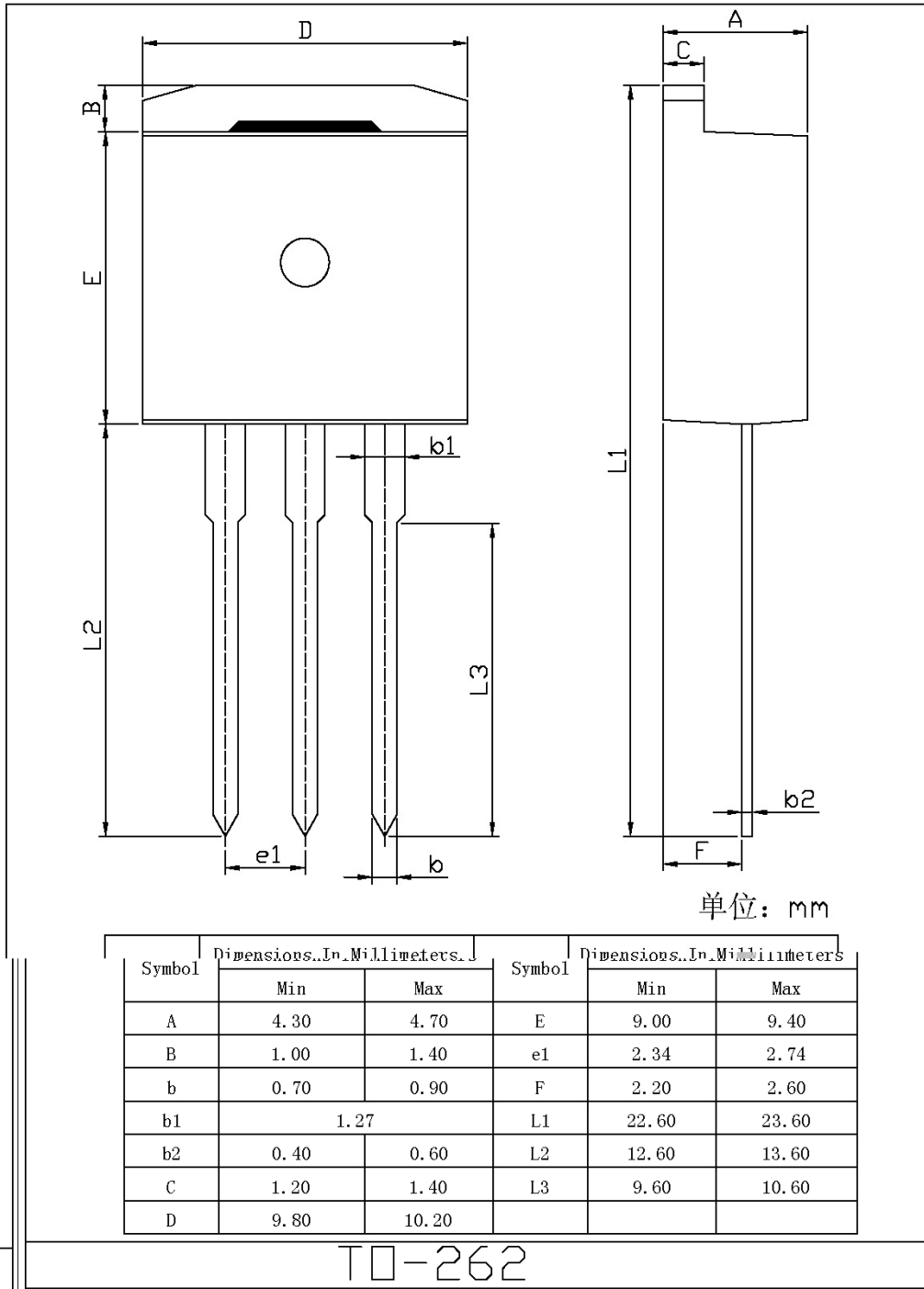
$I_D - T_C$



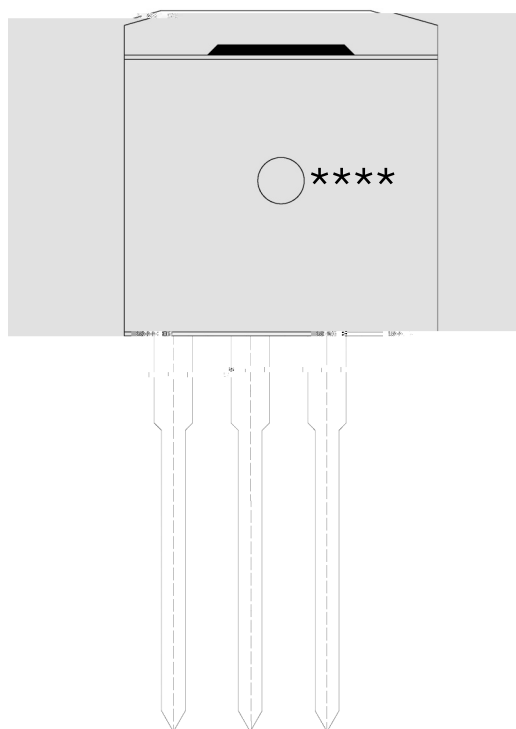
I_D



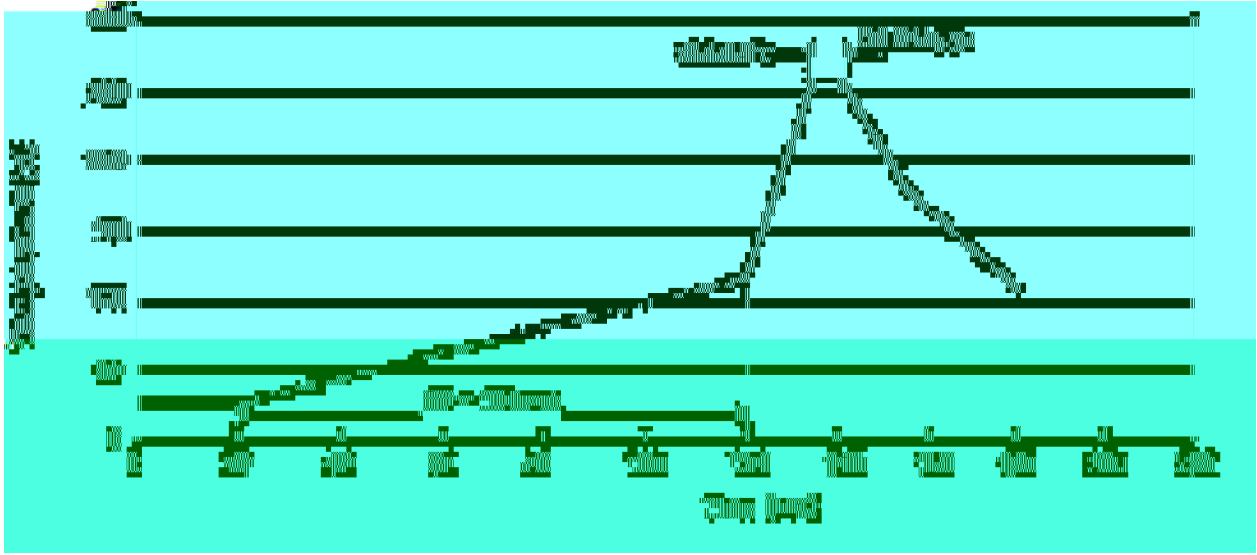
/ Package Dimensions



/ Marking Instructions



() / Temperature Profile for Dip Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

封装形式	包装数量					包装尺寸 :		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
T0-262	50	20	1,000	5	5,000	532×31.4×5.5	555×164×50	575×290×180